

**REPLY UNDER 37 C.F.R. § 1.116
EXPEDITED PROCEDURE
TECHNOLOGY CENTER ART UNIT 2813**

Attorney Docket: 040008-0307078
Client Reference: OF03P195/US

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JUN 28 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of: LEE

Confirmation Number: 8236

Application No.: 10/733,276

Group Art Unit: 2813

Filed: December 12, 2003

Examiner: Nguyen, Thanh T.

Title: METHOD OF MANUFACTURING A SEMICONDUCTOR DEVICE WITHOUT
OXIDIZED COPPER LAYER (AS AMENDED)

AMENDMENT AFTER FINAL REJECTION UNDER 37 C.F.R. § 1.116

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated March 30, 2005, please amend the above-identified application as follows:

Do Not File
7/6/05

30536998v1

PAGE 6/13 * RCVD AT 6/28/2005 4:44:26 PM [Eastern Daylight Time] * SVR:USPTO-EFXRF-1/5 * DNIS:8729306 * CSID:+703 905 2500 * DURATION (mm:ss):03:42